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# RENESAS SEMICONDUCTOR RELIABILITY REPORT

DEVICE: RAJ240100A20GFP#HC3

APPLICATION: Standard

Quality Assurance Div.  
Renesas Electronics Corporation

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## Reliability test result

| Test Items                           | Reference                 | Test Conditions  | Results<br>Reject/Size |
|--------------------------------------|---------------------------|--|------------------------|
| High Temperature Operating Life      | JESD22-A108               | Tj = 125 °C, Vcc max, 1000 h   | 0/22                   |
| High Temperature Storage Life        | JESD22-A103               | Ta = 150 °C, 1000 h  | 0/22                   |
| Temperature Humidity Bias (HAST)     | JESD22-A110               | Ta = 110 °C, 85% RH, Vcc max, 264 h  | 0/22                   |
| Temperature Cycling                  | JESD22-A104               | Ta = -65 °C to +150 °C, 200 cycles   | 0/22                   |
| Resistance to Soldering Heat         | JESD22-A113,<br>J-STD-020 | Bake: 125 °C, 24 h<br>Moisture Soak: 30 °C 70% RH, 192 h (JEDEC-MSL3)<br>Reflow: 260 °C peak, 3times | 0/22                   |
| Solderability                        | J-STD-002                 | 245 °C, 5 s<br>95% solder coverage minimum   | 0/5                    |
| Electrostatic discharge (HBM Method) | JS-001                    | C = 100 pF, R = 1.5 kΩ, ±2000 V  | 0/3                    |
| Electrostatic discharge (CDM Method) | JESD22-C101               | ±500 V   | 0/3                    |
| Latch-up (I-Test)                    | JESD78                    | ±100 mA  | 0/3                    |
| Estimated Failure Rate               | -                         | 10 FIT or less<br>Prerequisites: Ta = 55 °C, C.L. = 60%  |                        |

Reliability test results may include data from family representative products. MSL Preconditioning was performed prior to Temperature Humidity Bias and Temperature Cycling.

The Criteria shall follow the electrical characteristics in Specifications, except for Solderability.

Preconditioning Details: Bake (125 °C, 24 h) -> Moisture Soak (30 °C 70% RH, 192 h) -> Reflow (260 °C peak, 3 times)